

# N-Channel 80-V (D-S) MOSFET

## Description

The device is using trench DMOS technology. This advanced technology has been especially tailored to minimize  $R_{DS(ON)}$ , provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

The device meets the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

#### **Features**

- R<sub>DS(ON)</sub> =8.7mΩ @ V<sub>GS</sub> =10V
- Super Low Gate Charge
- Excellent dv/dt Capability
- 100% EAS Guaranteed
- Green Device Available

### **Typical Applications**

- Networking
- Load Switch
- Synchronous Rectifier
- Quick Charger

Package type: PDFN 5X6

### **Packing & Order Information**

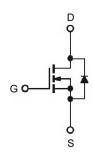
3,000/Reel



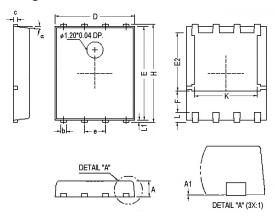


RoHS Compliant

### **Graphic Symbol**

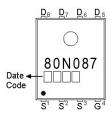


### **Package Dimension**



REF.	Millimeter		REF.	Millimeter				
	Min.	Nom.	Max.	REF.	Min.	Nom.	Max.	
Α	0.85	1.00	1.15	Е	5.70	-	5.90	
A1	0.00	-	0.10	е	-	1.27	-	
b	0.30	-	0.51	Н	5.90	-	6.20	
С	0.20	-	0.30	L	-	0.60	-	
D	4.80	-	5.00	L1	0.06	-	0.20	
F	1.10 Ref.		α	0°	-	12°		
E2	3	3.50 Ref.		K	3.70	3.90	4.10	

### Marking





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### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings					
Symbol	Parameter	Value	Units		
V <sub>DS</sub>	Drain-Source Voltage	80	V		
V <sub>G</sub> s	Gate-Source Voltage	±20	V		
I <sub>D</sub>	Continuous Drain Current¹ (Tc =25°C)	60	Α		
	Continuous Drain Current¹ (Tc=100°C)	38	Α		
I <sub>DM</sub>	Pulsed Drain Current <sup>1,2</sup>	170	Α		
las	Single Pulse Avalanche Current, L =0.1mH³	30	Α		
Eas	Single Pulse Avalanche Energy, L =0.1mH³	45	mJ		
PD	Power Dissipation <sup>4</sup> (T <sub>C</sub> =25°C)	52	W		
T <sub>J</sub> /T <sub>STG</sub>	Operating Junction and Storage Temperature	-55 to 175	°C		

Thermal Resistance Ratings						
Symbol	Parameter	Maximum	Units			
$R_{\theta JA}$	Maximum Junction-to-Ambient <sup>1</sup>	65	°C/W			
R <sub>0JC</sub>	Maximum Junction-to-Case <sup>1</sup>	2.5	°C/W			

Electrical Characteristics (T <sub>J</sub> =25°C unless otherwise specified)						
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
$V_{\text{GS (th)}}$	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.2	-	2.3	V
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	80	-	_	V
Igss	Gate-Source Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =64V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C V <sub>DS</sub> =64V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C	-	-	1 5	μA
R <sub>DS</sub> (on)	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	-	7.2 10.5	8.7 13	mΩ
EAS	Single Pulse Avalanche Energy <sup>5</sup>	V <sub>DD</sub> =50V, L =0.1mH, I <sub>AS</sub> =15A	11	-	-	mJ
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	I <sub>S</sub> =1A, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	-	-	1.2	V
Is	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current	-	-	30	
Ism	Pulsed Source Current <sup>2,6</sup>		-	-	60	Α

#### Notes

- 1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2. The data tested by pulsed, pulse width  $\leq$  300us, duty cycle  $\leq$  2%.
- 3. The EAS data shows maximum rating. The test condition is  $V_{DD}$ =50,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =30A.
- 4. The power dissipation is limited by 175°C junction temperature.
- 5. The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



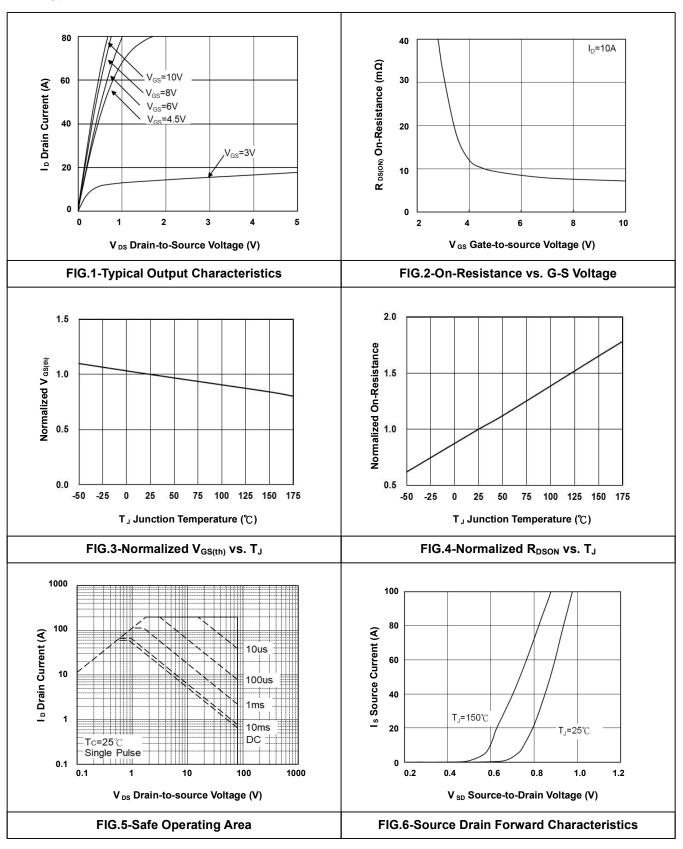
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Dynamic						
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Qg	Total Gate Charge <sup>2</sup>	V <sub>DS</sub> =40V		29		
Qgs	Gate-Source Charge	I <sub>D</sub> =10A		7.7		nC
Qgd	Gate-Drain Charge	V <sub>GS</sub> =10V		5.3		
td(on)	Turn-On Delay Time <sup>2</sup>	V <sub>DS</sub> =40V		6.2		
tr	Rise Time	I <sub>D</sub> =10A		19		
td(off)	Turn-Off Delay Time	V <sub>GS</sub> =10V		9.4		ns
tf	Fall Time	R <sub>G</sub> =3.3Ω		36		
Cıss	Input Capacitance	V <sub>DS</sub> =40V		1738		
Coss	Output Capacitance	V <sub>GS</sub> =0V		317		pF
Crss	Reverse Transfer Capacitance	f=1.0MHz		12		
trr	Reverse Recovery Time	I- 404 II/II 4004/ Ti 0500		35		nS
Qrr	Reverse Recovery Charge	IF=10A, dl/dt=100A/μs, Tj=25°C		62		nC
Rg	Gate Resistance	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f =1.0MHz		1.5		Ω



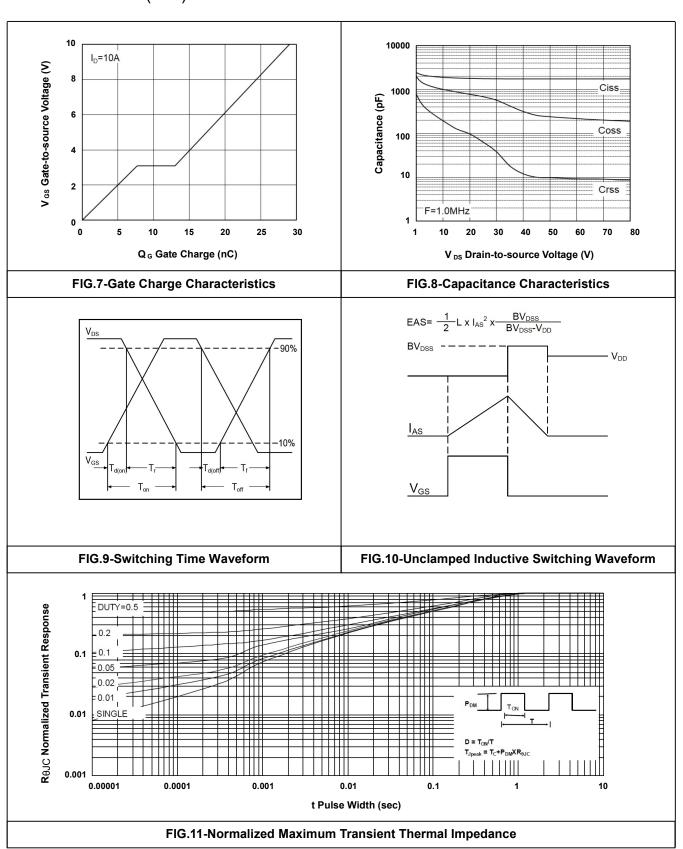
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## • Typical Electrical Characteristics





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